

## Chapter 1

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# Cyclic Redundancy Check (CRC) Module

**NOTE:** This chapter is an excerpt from the *MSP430x5xx* and *MSP430x6xx* Family User's Guide. The most recent version of the full user's guide is available at

http://www.ti.com/lit/pdf/slau208.

The cyclic redundancy check (CRC) module provides a signature for a given data sequence. This chapter describes the operation and use of the CRC module.

 $\textbf{NOTE:} \quad \text{The CRC module on the MSP430F543x and MSP430F541x non-A versions does not}$ 

support the bit-wise reverse feature described in this module description. Registers CRCDIRB and CRCRESR, along with their respective functionality, are not available.

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### 1.1 Cyclic Redundancy Check (CRC) Module Introduction

The CRC module produces a signature for a given sequence of data values. The signature is generated through a feedback path from data bits 0, 4, 11, and 15 (see Figure 1-1). The CRC signature is based on the polynomial given in the CRC-CCITT-BR polynomial (see Equation 1).

$$f(x) = x^{16} + x^{12} + x^5 + 1 \tag{1}$$

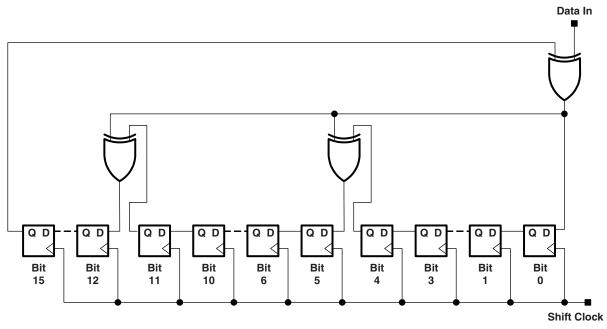


Figure 1-1. LFSR Implementation of CRC-CCITT Standard, Bit 0 is the MSB of the Result

Identical input data sequences result in identical signatures when the CRC is initialized with a fixed seed value, whereas different sequences of input data, in general, result in different signatures.

#### 1.2 CRC Standard and Bit Order

The definitions of the various CRC standards were done in the era of main frame computers, and by convention bit 0 was treated as the MSB. Today, as in most microcontrollers such as the MSP430, bit 0 normally denotes the LSB. In Figure 1-1, the bit convention shown is as given in the original standards i.e. bit 0 is the MSB. The fact that bit 0 is treated for some as LSB, and for others as MSB, continues to cause confusion. The CRC16 module therefore provides a bit reversed register pair for CRC16 operations to support both conventions.



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#### 1.3 CRC Checksum Generation

The CRC generator is first initialized by writing a 16-bit word (seed) to the CRC Initialization and Result (CRCINIRES) register. Any data that should be included into the CRC calculation must be written to the CRC Data Input (CRCDI or CRCDIRB) register in the same order that the original CRC signature was calculated. The actual signature can be read from the CRCINIRES register to compare the computed checksum with the expected checksum.

Signature generation describes a method on how the result of a signature operation can be calculated. The calculated signature, which is computed by an external tool, is called checksum in the following text. The checksum is stored in the product's memory and is used to check the correctness of the CRC operation result.

### 1.3.1 CRC Implementation

To allow parallel processing of the CRC, the linear feedback shift register (LFSR) functionality is implemented with an XOR tree. This implementation shows the identical behavior as the LFSR approach after 8 bits of data are shifted in when the LSB is 'shifted' in first. The generation of a signature calculation has to be started by writing a seed to the CRCINIRES register to initialize the register. Software or hardware (for example, DMA) can transfer data to the CRCDI or CRCDIRB register (for example, from memory). The value in CRCDI or CRCDIRB is then included into the signature, and the result is available in the signature result registers at the next read access (CRCINIRES and CRCRESR). The signature can be generated using word or byte data.

If a word data is processed, the lower byte at the even address is used at the first clock (MCLK) cycle. During the second clock cycle, the higher byte is processed. Thus, it takes two clock cycles to process word data, while it takes only one clock (MCLK) cycle to process byte data.

Data bytes written to CRCDIRB in word mode or the data byte in byte mode are bit-wise reversed before the CRC engine adds them to the signature. The bits among each byte are reversed. Data bytes written to CRCDI in word mode or the data byte in byte mode are not bit reversed before use by the CRC engine.

If the Check Sum itself (with reversed bit order) is included into the CRC operation (as data written to CRCDI or CRCDIRB), the result in the CRCINIRES and CRCRESR registers must be zero.



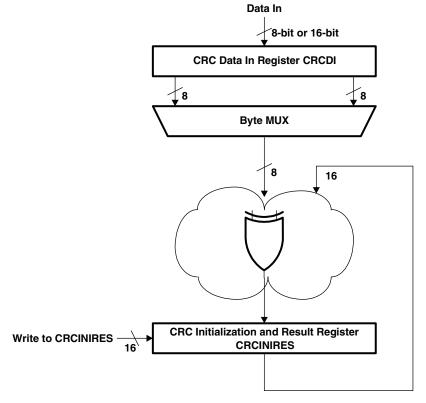


Figure 1-2. Implementation of CRC-CCITT Using the CRCDI and CRCINIRES Registers

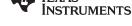
#### 1.3.2 Assembler Examples

### 1.3.2.1 General Assembler Example

This example demonstrates the operation of the on-chip CRC:

```
PUSH
         R4
                             ; Save registers
  PUSH
  VOM
         #StartAddress,R4
                           ; StartAddress < EndAddress
         #EndAddress,R5
  MOV
  MOV
         &INIT, &CRCINIRES ; INIT to CRCINIRES
L1 MOV
         @R4+,&CRCDI
                            ; Item to Data In register
  CMP
         R5,R4
                            ; End address reached?
  JLO
                            ; No
  MOV
         &Check_Sum, &CRCDI ; Yes, Include checksum
  TST
         &CRCINIRES
                            ; Result = 0?
  JNZ
         CRC_ERROR
                            ; No, CRCRES <> 0: error
                            ; Yes, CRCRES=0:
                            ; information ok.
  POP
         R5
                            ; Restore registers
  POP
         R4
```





#### 1.3.2.2 Reference Data Sequence

The details of the implemented CRC algorithm is shown by the following data sequences using word or byte accesses and the CRC data-in as well as the CRC data-in reverse byte registers:

```
#0FFFFh, &CRCINIRES ; initialize CRC
mov
mov.b
        #00031h,&CRCDI L
                            ; "1"
        #00032h,&CRCDI_L
                            ; "2"
mov.b
                            ; "3"
        #00033h,&CRCDI_L
mov.b
                            ; "4"
mov.b
        #00034h,&CRCDI_L
                            ; "5"
mov.b
        #00035h,&CRCDI_L
        #00036h,&CRCDI_L
mov.b
mov.b
        #00037h,&CRCDI L
                            ; "7"
mov.b
        #00038h,&CRCDI_L
                            ; "8"
mov.b
                            ; "9"
        #00039h,&CRCDI_L
        #089F6h, &CRCINIRES ; compare result
cmp
                            ; CRCRESR contains 06F91h
iea
        &Success
                            ; no error
        &Error
                            ; to error handler
br
        #0FFFFh,&CRCINIRES ; initialize CRC
mov
                          ; "1" & "2"
        #03231h,&CRCDI
mov.w
                            ; "3" & "4"
        #03433h,&CRCDI
mov.w
                           ; "5" & "6"
        #03635h,&CRCDI
mov.w
                           ; "7" & "8"
        #03837h,&CRCDI
mov.w
                            ; "9"
mov.b
        #039h, &CRCDI_L
        #089F6h, &CRCINIRES ; compare result
cmp
                               ; CRCRESR contains 06F91h
                            ; no error
jeq
        &Success
br
        &Error
                            ; to error handler
        #0FFFFh,&CRCINIRES ; initialize CRC
mov
        #00031h,&CRCDIRB_L ; "1"
mov.b
        #00032h,&CRCDIRB_L ; "2"
mov.b
mov.b
        #00033h,&CRCDIRB_L ; "3"
mov.b
        #00034h,&CRCDIRB_L ; "4"
        #00035h,&CRCDIRB_L ; "5"
mov.b
        #00036h, & CRCDIRB L ; "6"
mov.b
        #00037h,&CRCDIRB_L ; "7"
mov.b
        #00038h,&CRCDIRB_L ; "8"
mov.b
        #00039h,&CRCDIRB_L ; "9"
mov.b
        #029B1h,&CRCINIRES ; compare result
cmp
                            ; CRCRESR contains 08D94h
iea
        &Success
                            ; no error
        &Error
                            ; to error handler
br
       #0FFFFh,&CRCINIRES ; initialize CRC
mov
      #03231h,&CRCDIRB ; "1" & "2"
mov.w
mov.w
      #03433h,&CRCDIRB ; "3" & "4"
      #03635h,&CRCDIRB ; "5" & "6"
mov.w
      #03837h,&CRCDIRB ; "7" & "8"
mov.w
      #039h, &CRCDIRB_L ; "9"
mov.b
       #029B1h, &CRCINIRES ; compare result
cmp
                         ; CRCRESR contains 08D94h
jeq
       &Success
                         ; no error
                         ; to error handler
br
       &Error
```

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#### 1.4 **CRC Registers**

The CRC module registers are listed in Table 1-1. The base address can be found in the device-specific data sheet. The address offset is given in Table 1-1.

NOTE: All registers have word or byte register access. For a generic register ANYREG, the suffix "\_L" (ANYREG\_L) refers to the lower byte of the register (bits 0 through 7). The suffix "\_H" (ANYREG\_H) refers to the upper byte of the register (bits 8 through 15).

Table 1-1. CRC Registers

Offset	Acronym	Register Name	Туре	Access	Reset	Section
0000h	CRCDI	CRC Data In	Read/write	Word	0000h	Section 1.4.1
0000h	CRCDI_L		Read/write	Byte	00h	
0001h	CRCDI_H		Read/write	Byte	00h	
0002h	CRCDIRB	CRC Data In Reverse Byte <sup>(1)</sup>	Read/write	Word	0000h	Section 1.4.2
0002h	CRCDIRB_L		Read/write	Byte	00h	
0003h	CRCDIRB_H		Read/write	Byte	00h	
0004h	CRCINIRES	CRC Initialization and Result	Read/write	Word	FFFFh	Section 1.4.3
0004h	CRCINIRES_L		Read/write	Byte	FFh	
0005h	CRCINIRES_H		Read/write	Byte	FFh	
0006h	CRCRESR	CRC Result Reverse <sup>(1)</sup>	Read only	Word	FFFFh	Section 1.4.4
0006h	CRCRESR_L		Read/write	Byte	FFh	
0007h	CRCRESR_H		Read/write	Byte	FFh	

Not available on MSP430F543x and MSP430F541x non-A versions.

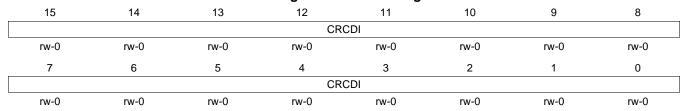


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### 1.4.1 CRCDI Register

CRC Data In Register

### Figure 1-3. CRCDI Register



### **Table 1-2. CRCDI Register Description**

E	Bit	Field	Туре	Reset	Description
1	5-0	CRCDI	RW		CRC data in. Data written to the CRCDI register is included to the present signature in the CRCINIRES register according to the CRC-CCITT standard.

### 1.4.2 CRCDIRB Register

CRC Data In Reverse Register

### Figure 1-4. CRCDIRB Register

15	14	13	12	11	10	9	8		
	CRCDIRB								
rw-0	rw-0	rw-0	rw-0	rw-0	rw-0	rw-0	rw-0		
7	6	5	4	3	2	1	0		
			CRC	DIRB					
rw-0	rw-0	rw-0	rw-0	rw-0	rw-0	rw-0	rw-0		

### **Table 1-3. CRCDIRB Register Description**

Bit	Field	Туре	Reset	Description
15-0	CRCDIRB	RW		CRC data in reverse byte. Data written to the CRCDIRB register is included to the present signature in the CRCINIRES and CRCRESR registers according to the CRC-CCITT standard. Reading the register returns the register CRCDI content.

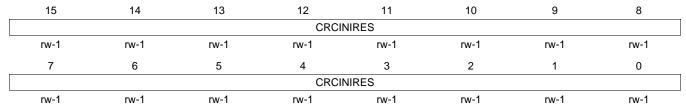


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### 1.4.3 CRCINIRES Register

CRC Initialization and Result Register

### Figure 1-5. CRCINIRES Register



### **Table 1-4. CRCINIRES Register Description**

Bit	Field	Туре	Reset	Description
15-0	CRCINIRES	RW	FFFFh	CRC initialization and result. This register holds the current CRC result (according to the CRC-CCITT standard). Writing to this register initializes the CRC calculation with the value written to it. The value just written can be read from CRCINIRES register.

### 1.4.4 CRCRESR Register

CRC Reverse Result Register

### Figure 1-6. CRCRESR Register

15	14	13	12	11	10	9	8	
	CRCRESR							
r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1	
7	6	5	4	3	2	1	0	
			CRC	RESR				
r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1	

### Table 1-5. CRCRESR Register Description

Bit	Field	Туре	Reset	Description
15-0	CRCRESR	R	FFFFh	CRC reverse result. This register holds the current CRC result (according to the CRC-CCITT standard). The order of bits is reversed (for example, CRCINIRES[15] = CRCRESR[0]) compared to the order of bits in the CRCINIRES register (see example code).

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